



## TLF

# Base material for Power Amplifier

TLF is an organic-ceramic laminate in Taconic's family of products. It is based on woven glass reinforcement. And is the best choice for low cost, high volume commercial microwave and radio frequency application.

TLF has excellent peel strength for ½ ounce and 1 ounce copper(even in comparison to standard epoxy materials), a critical aspect whenever rework is required. And is designed to offer superior high frequency performance. And ultra low moisture absorption rate and low dissipation factor minimize phase shift with frequency. TLF is dimensionally stable due to the use of woven fabrics in its design.

#### **Benefits**

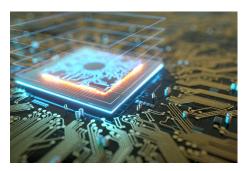
- Exceptionally low loss
- Stable at high frequency
- Stable at high temp.
- Low moisture absorption
- Excellent Peel Strength
- Excellent price/performance Ratio

### **Applications**

- Power Amplifiers
- LNA, Repeater PA
- Passive Components
- Filters/Couplers







### Asia/Australia Korea Taconic Company

Republic of Korea Tel: +82-31-704-1858 agc-ml.ktc-sales@agc.com www.agc-multimaterial.com

# China AGC Multi Material (Suzhou) Inc.

Suzhou City, China Tel: +86-512-286-7170 tssales@taconic.co.kr www.agc-multimaterial.com

#### Europe/Middle East AGC Multi Material Europe SA

Lannemezan, France Tel: +33-05-6298-5290 neltecsasales@agc-nelco.com www.agc-multimaterial.com

# North&South America AGC Nelco America Inc.

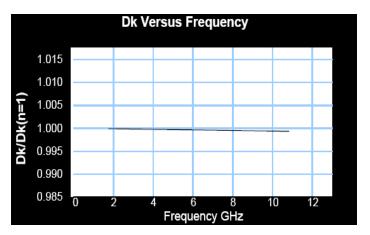
Tempe, AZ USA 85281 Tel: +602-679-9196 TaconicPO@agc-nelco.com www.agc-multimaterial.com

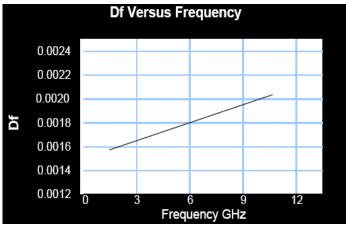




TLF TYPICAL VALUES						
Property	Test Method	Unit	Value	Unit	Value	
Dielectric Constant @ 1.9 GHz	IPC-TM 650 2.5.5.5.1 Mod		TLF-34:3.40 TLF-35:3.50		TLF-34:3.40 TLF-35:3.50	
Dissipation Factor @ 1.9 GHz	IPC-TM 650 2.5.5.5.1 Mod		0.0016		0.0016	
Dissipation Factor @ 10 GHz	IPC-TM 650 2.5.5.5.1 Mod		0.0020		0.0020	
Water absorption	IPC-TM 650 2.6.2.1	%	0.02	%	0.02	
Peel Strength (1 oz. copper)	IPC-TM 650 2.4.8	Lbs./linear inch	10	N/mm	1.8	
Volume Resistivity	IPC-TM 650 2.5.17.1	Mohm·cm	1.7 x 10 <sup>9</sup>	Mohm·cm	1.7 x 10 <sup>9</sup>	
Surface Resistivity	IPC-TM 650 2.5.17.1	Mohm	2.8 x 10 <sup>8</sup>	Mohm	2.8 x 10 <sup>8</sup>	
Flexural Strength Lengthwise	IPC-TM 650 2.4.4	psi	18,500	N/mm²	128	
Flexural Strength Crosswise	IPC-TM 650 2.4.4	psi	14,500	N/mm²	100	
Thermal Conductivity	ASTM F433	W/m/K	0.36	W/m/K	0.36	
x-y CTE (50 ~ 150°C)	ASTM D3386 (TMA)	ppm/°C	21-23	ppm/°C	21-23	
z CTE (50 ~ 150°C)	ASTM D3386 (TMA)	ppm/°C	85	ppm/°C	85	
Flammability	UL-94		V-0		V-0	

Ту	Dk		
TLY	TLY-5A		
TL	Y-5	2.20	
TL	Y-3	2.33	
TLT-0	TLX-0	2.45	
TLT-9	TLX-9	2.50	
TLT-8	TLX-8	2.55	
TLT-7	TLT-7 TLX-7		
TLT-6	TLX-6	2.65	
TLE	TLE-95		
TLC	C-27	2.75	
TLC-30	RF-30	3.00	
TLC	3.20		
TLF	3.40		
TLF	3.50		
RF-35	RF-35A2	3.50	
TRF	4.10		
TRF	4.30		
TRF	4.50		
RF-	6.15		
CEF	10		





Remark: All reported values are typical and should not be used for specification purposes. In all instances, the user shall determine suitability In any given application.



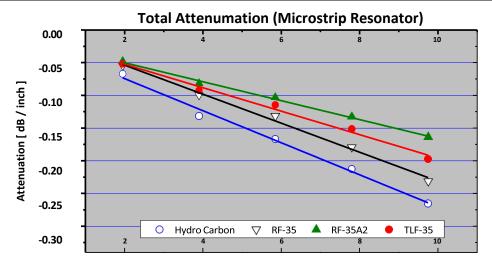


How to Order					
Design	nation	Dielectric			
TLF-34		3.4 +/07			
TLF-35		3.5 +/07			
Typical Thicknesses 1		Typical Thicknesses 2			
Inches	mm	Inches	mm		
0.0100	0.25	12 x 18	305 x 457		
0.0100		16 x 18	406 x 457		
0.0200	0.54	18 x 24	457 x 610		
	0.51	16 x 36	406 x 914		
0.0300	0.76	24 x 36	610 x 914		
0.0600	1.52	18 x 48	457 x 1220		

- 1) TLF series can be manufactured in increments of 0.0100". Please call for availability of additional thicknesses.
- 2) Our Standard sheet size is 36"\*48"(914mm X 1220mm).

  Please contact our customer service department for availability of other size.

Available Copper Cladding						
Designation	Weight	Copper 1	Thickness	Rms Treated Side		Description
СН	½ oz./sq. ft.	~ .0007"	~ 18 <i>µ</i> m	27μin	0.7 <i>µ</i> m	Very low profile / Electrodeposited
C1	1 oz./sq. ft.	~ .0014"	~ 35 µm	25μin	0.6 <i>µ</i> m	Very low profile / Electrodeposited
C2	2 oz./sq. ft.	~ .0028"	~ 70 <i>µ</i> m	77μin	2.0 <i>µ</i> m	Electrodeposited



### Frequency [GHz]

Total Attenuation were measured with microstrip ring resonator. Material under test were 20mil dielectric thickness and 1 oz. copper.